

Hi-performance Regulator IC Series for PCs

PGOOD IC for PC



BD4140HFV

No.09030EBT18

●Description

BD4140HFV is 1ch reset IC for watching the voltage. The detected voltage is 0.5V, and it is available to several kinds of voltage with additional external resistance. For the independent supply voltage (V_{CC}), the "L" level of voltage is guaranteed in case the watching input voltage is also low.

●Features

- 1) Open drain output type
- 2) Built in Under Voltage LockOut (UVLO) circuit
- 3) HVSO5 package : 1.6 × 1.6 × 0.6(mm)

●Applications

Laptop PC, Desktop PC, LCD-TV, Printer, STV, Digital appliances

●Absolute maximum ratings (Ta=25°C)

| Parameter | Symbol | BD4140HFV | Unit |
|-----------------------------|----------------------------------|--------------------|------|
| Terminal voltage | V _{CC} , IN, DLY, PGOOD | 6 ^{*1} | V |
| Power Dissipation | P _d | 0.67 ^{*2} | W |
| PGOOD Capacity Current | I _{PGOOD} | 5 | mA |
| Operating temperature range | T _{opr} | -10~+100 | °C |
| Storage temperature range | T _{stg} | -55~+150 | °C |
| Junction Temperature | T _{jmax} | +150 | °C |

*1 Do not however exceed P_d.

*2 Reduced by $\theta_{ja}=186.6^{\circ}\text{C/W}$ for increase in Ta of 1°C over 25°C.

(when mounted on a board 70.0mm × 70mm × 1.6mm Glass-epoxy PCB which has 1 layer. (copper foil density :2%))

*3 Reduced by $\theta_{ja}=185.2^{\circ}\text{C/W}$ for increase in Ta of 1°C over 25°C

(when mounted on a board 70.0mm × 70mm × 1.6mm Glass-epoxy PCB which has 1 layer.)

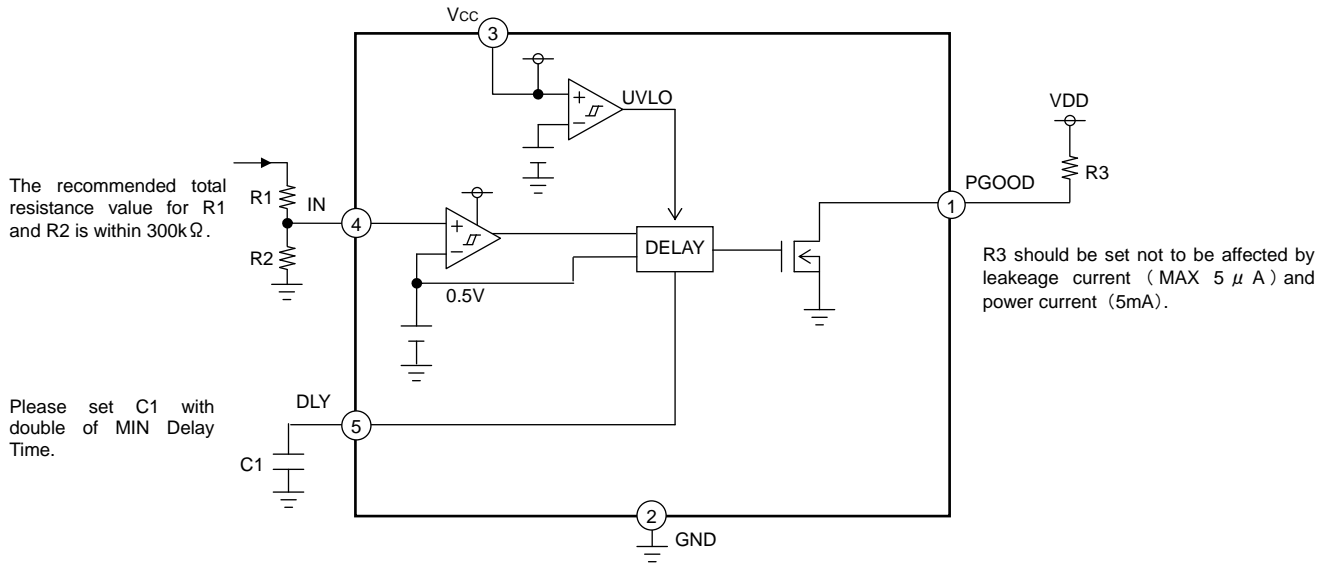
●Operating Conditions (Ta=25°C)

| Parameter | Symbol | Min. | Max. | Unit |
|------------------|-----------------|------|--------------------|------|
| Terminal voltage | V _{CC} | 3.0 | 5.5 | V |
| | IN | -0.3 | V _{CC} -2 | V |
| | PGOOD | -0.3 | 5.5 | V |
| | DLY | -0.3 | V _{CC} | V |

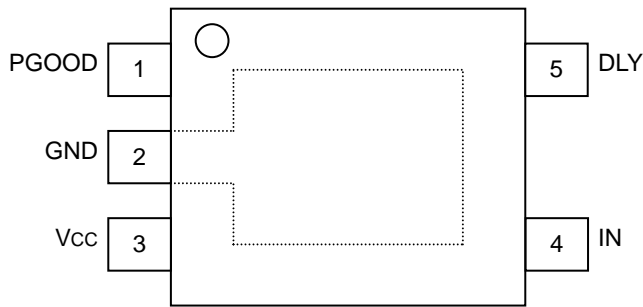
●ELECTRICAL CHARACTERISTICS (Unless otherwise noted, Ta=25°C, V_{CC}=5V)

| Parameter | Symbol | Limits | | | Unit | Conditions |
|----------------------------|-------------------|--------|------|------|------|---------------|
| | | Min. | Typ. | Max. | | |
| Bias Current | I _{CC} | - | 5 | 10 | μA | - |
| Detected Voltage | V _{DET} | 491 | 500 | 509 | mV | IN sweep up |
| Hysteresis Voltage | V _{HYS} | - | 10 | - | mV | IN sweep down |
| Delay Current | I _{DLY} | 150 | 250 | 350 | nA | IN=0.6V |
| PGOOD Output ON Resistance | R _{VOUT} | - | 100 | 200 | Ω | IN=0V |
| PGOOD Output Leak Current | I _{OUT} | - | 0 | 5 | μA | IN=0.6V |

●Block Diagram



●Pin Layout



●Pin Function Table

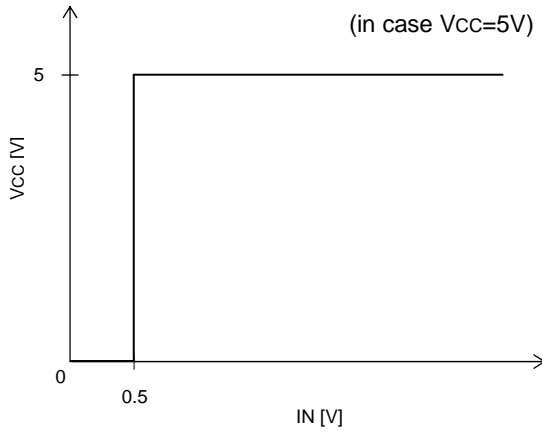
| PIN No. | PIN Name | PIN Function |
|---------|----------|--|
| 1 | PGOOD | Reset Output Pin (Power Good Signal) |
| 2 | GND | Ground Pin |
| 3 | Vcc | Power Supply Input Pin |
| 4 | IN | Watching Voltage Input Pin |
| 5 | DLY | Capacitor connected pin for setting delay time |
| Bottom | FIN | Substrate |

●Explanation of Operation

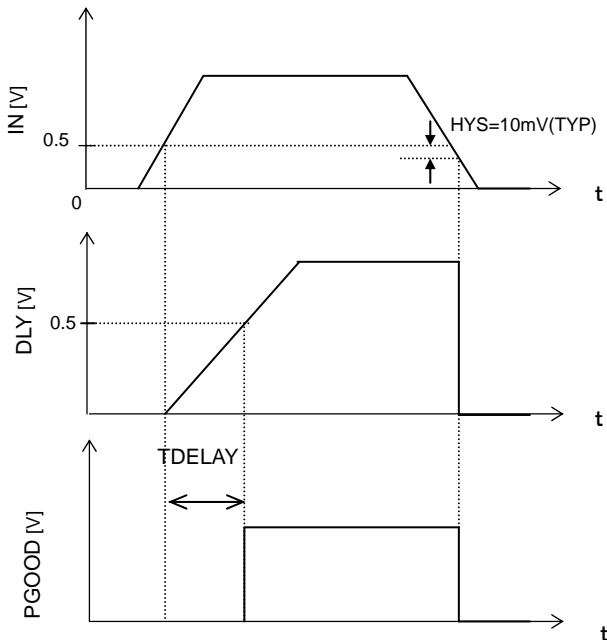
BD4140HFV is 1ch reset IC with independent supply voltage.

The following voltage is available to input VCC voltage before the watching input voltage.

(Input-output voltage characteristic)



(Detected delay time setting)



T_{DELAY} is calculated with formula below.

$$T_{DELAY} [sec] = \frac{C_{EXT} [\mu F] \times 0.5}{0.25 [\mu A]}$$

$$= 2 \times C_{EXT}[pF] \times 10^{-6}$$

$$C_{EXT} [pF] = T_{DELAY} [sec] / (2 \times 10^{-6})$$

(Example) When using the 4700pF capacitor,

$$T_{DELAY} [sec] = 2 \times 4700 [pF] \times 10^{-6}$$

$$= 9400 \times 10^{-6} = 9.4 [ms]$$

(Example) When setting 2ms Delay,

$$C_{EXT} = 2 [ms] \times 0.25 [\mu A] / 0.5$$

$$= \frac{2 \times 10^{-3} \times 0.25 \times 10^{-6}}{0.5}$$

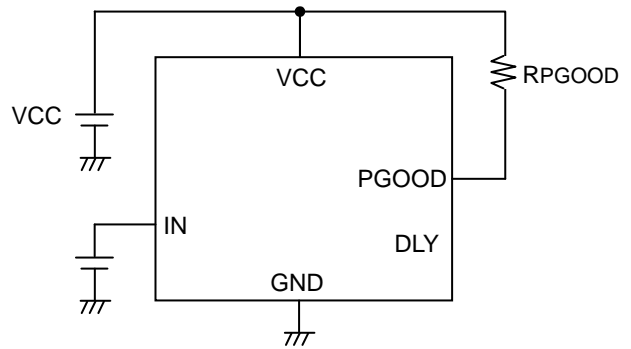
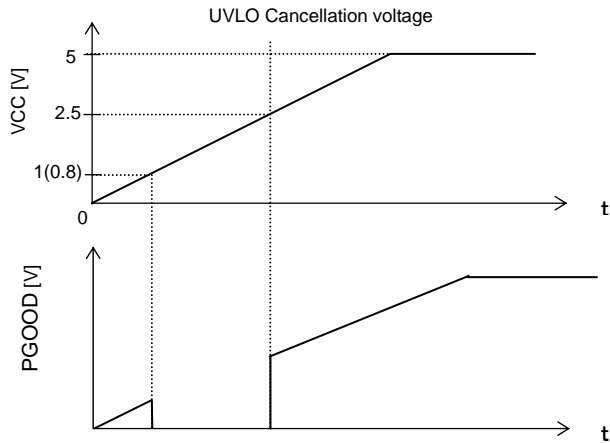
$$= 1 \times 10^{-9}$$

$$= 1000[pF]$$

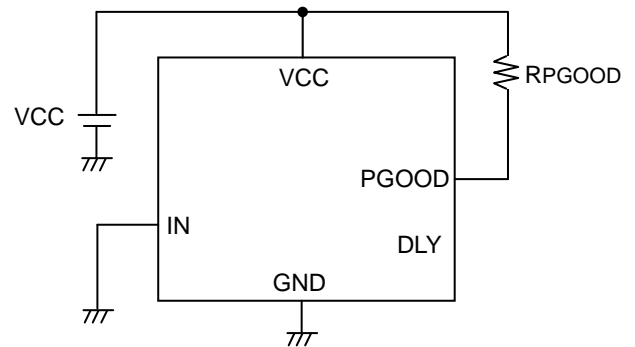
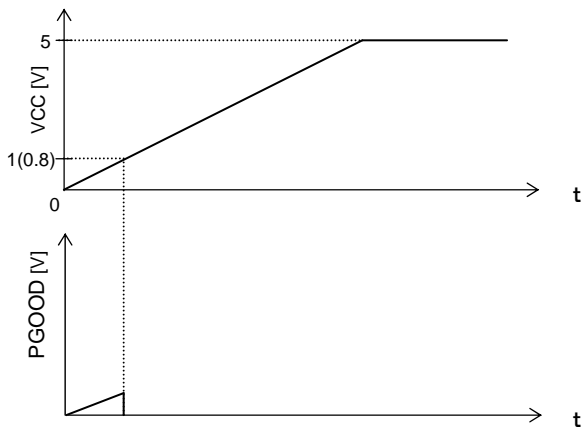
<VCC starting>

- ① When VCC is below the minimum operation voltage, PGOOD pin will be at H level.
(The meaning of the minimum operation voltage is : When the starting of VCC, PGOOD output voltage become within 10% of VCC voltage, and the value will be around 0.8VTYP(RPGOOD=100kΩ) and 1.0VTYP(RPGOOD=10kΩ). But note that this value is reference.)
- ② If VCC value exceeds the minimum operation voltage, by the VCC reached UVLO cancellation voltage (2.5V TYP), PGOOD output become at L level.
- ③ If VCC exceeds UVLO cancellation voltage, when the input voltage of IN pin is over the detected voltage, PGOOD pin will be at H level, and when the input voltage of IN pin is below the detected voltage, PGOOD pin will be at L level.

(PGOOD=OK)



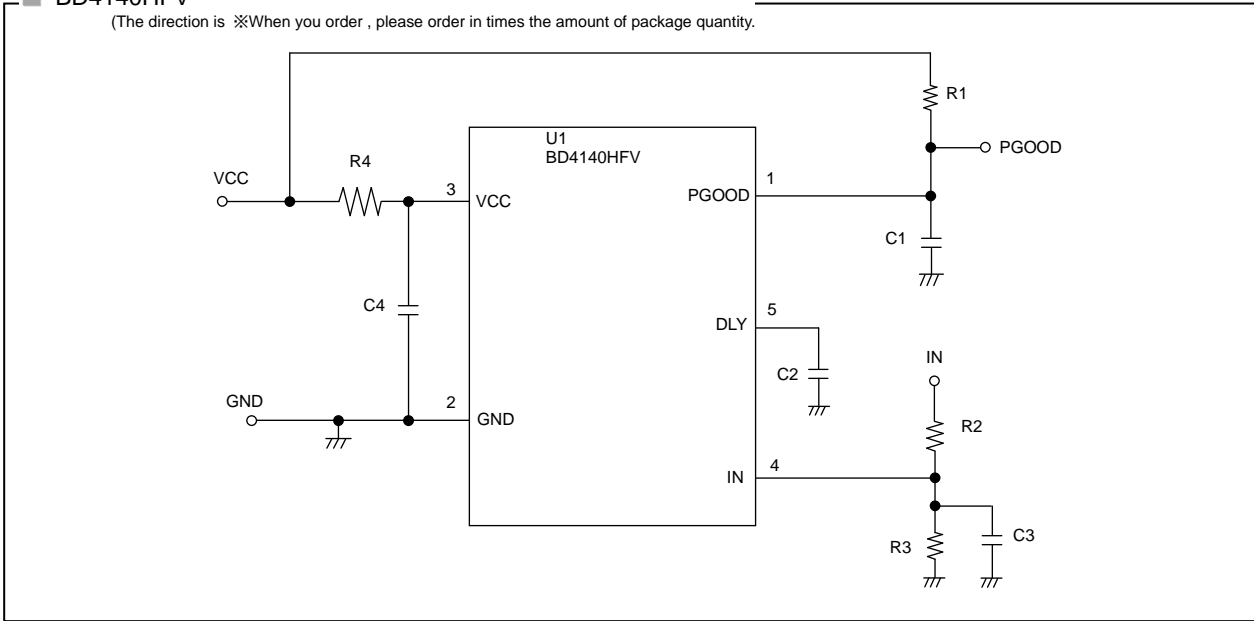
(PGOOD=NG)



● Evaluation Board Circuit

■ BD4140HFV

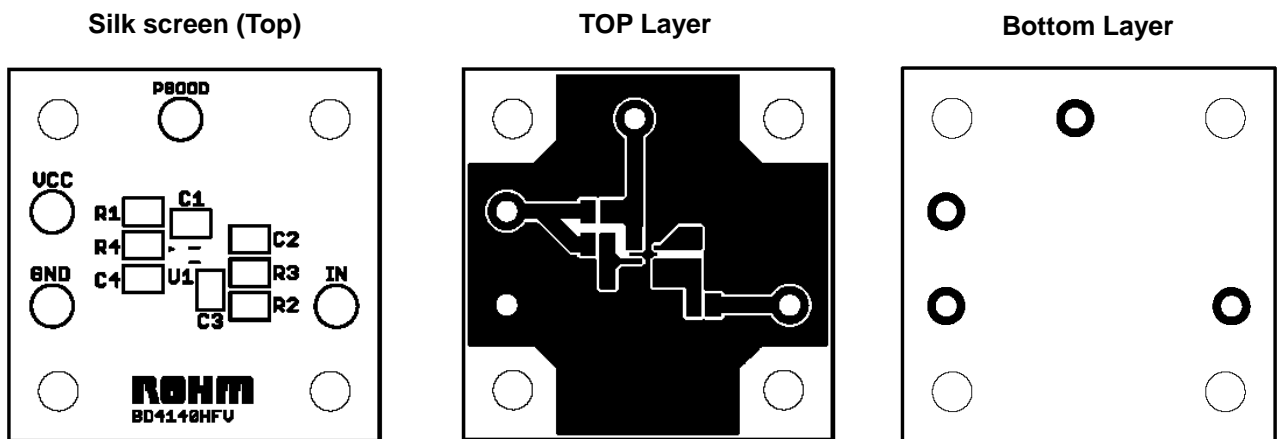
(The direction is ※When you order, please order in times the amount of package quantity.)



■ BD4140HFV Evaluation Board Standard Component List (at detecting 0.5V)

| Component | Rating | Manufacturer | Product Name | Component | Rating | Manufacturer | Product Name |
|-----------|--------|--------------|-------------------|-----------|--------|--------------|--------------|
| U1 | - | ROHM | BD4140HFV | R1 | 100kΩ | ROHM | |
| C1 | - | - | - | R2 | 0Ω | - | jumper |
| C2 | 1000pF | murata | GRM1552C1H102JA01 | R3 | - | - | - |
| C3 | - | - | - | R4 | 0Ω | - | jumper |
| C4 | - | - | - | | | | |

■ BD4140HFV Evaluation Board Layout



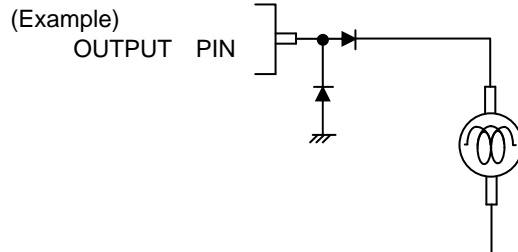
● Operation Notes

1. Absolute maximum ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down the devices, thus making impossible to identify breaking mode, such as a short circuit or an open circuit. If any over rated values will expect to exceed the absolute maximum ratings, consider adding circuit protection devices, such as fuses.

2. Power supply lines

Please add a protection diode when a large inductance component is connected to the output terminal, and reverse-polarity protection is possible at startup or in output OFF condition.



3. GND voltage

The potential of GND pin must be minimum potential in all operating conditions.

4. Inter-pin shorts and mounting errors

Use caution when positioning the IC for mounting on printed circuit boards. The IC may be damaged if there is any connection error or if pins are shorted together.

5. Actions in strong electromagnetic field

Use caution when using the IC in the presence of a strong electromagnetic field as doing so may cause the IC to malfunction.

6. Testing on application boards

When testing the IC on an application board, connecting a capacitor to a pin with low impedance subjects the IC to stress. Always discharge capacitors after each process or step. Always turn the IC's power supply off before connecting it to or removing it from a jig or fixture during the inspection process. Ground the IC during assembly steps as an antistatic measure. Use similar precaution when transporting or storing the IC.

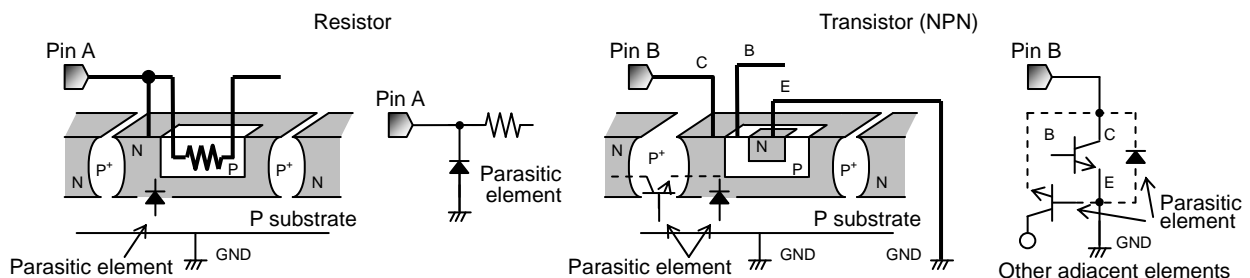
7. Regarding input pin of the IC

This monolithic IC contains P+ isolation and P substrate layers between adjacent elements in order to keep them isolated. P-N junctions are formed at the intersection of these P layers with the N layers of other elements, creating a parasitic diode or transistor. For example, the relation between each potential is as follows:

When $GND > Pin A$ and $GND > Pin B$, the P-N junction operates as a parasitic diode.

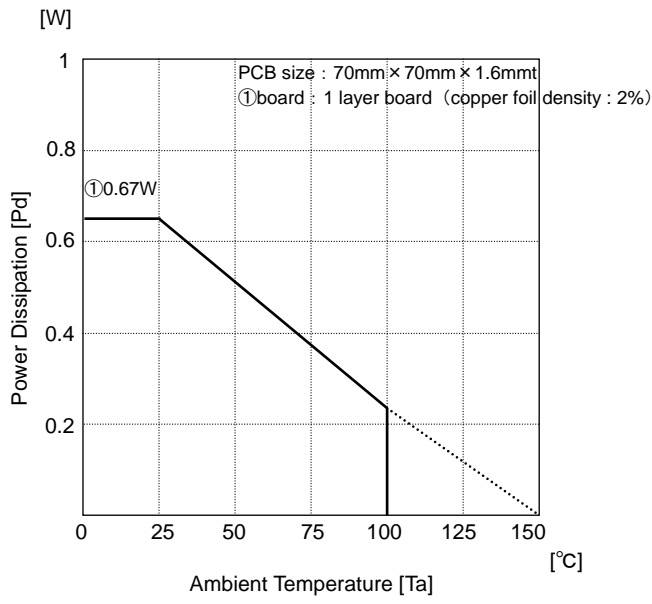
When $GND > Pin B$, the P-N junction operates as a parasitic transistor.

Parasitic diodes can occur inevitable in the structure of the IC. The operation of parasitic diodes can result in mutual interference among circuits, operational faults, or physical damage. Accordingly, methods by which parasitic diodes operate, such as applying a voltage that is lower than the GND (P substrate) voltage to an input pin, should not be used.



● Power Dissipation Characteristics

◎ HVSO5



●Ordering part number

| | |
|---|---|
| B | D |
|---|---|

Part No.

| | | | |
|---|---|---|---|
| 4 | 1 | 4 | 0 |
|---|---|---|---|

Part No.

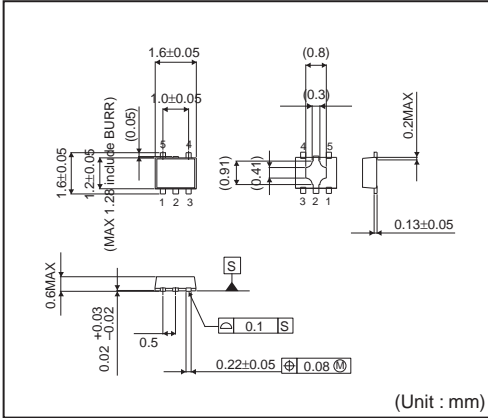
| | | |
|---|---|---|
| H | F | V |
|---|---|---|

Package
FV : HVSO5

| | |
|---|---|
| T | R |
|---|---|

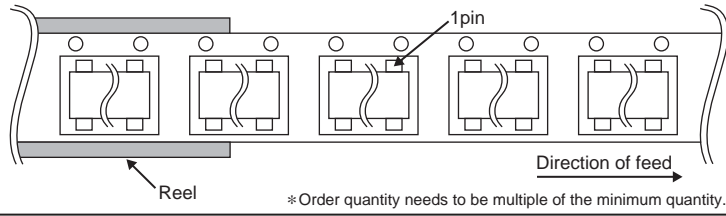
Packaging and forming specification
TR: Embossed tape and reel

HVSO5



<Tape and Reel information>

| | |
|-------------------|--|
| Tape | Embossed carrier tape |
| Quantity | 3000pcs |
| Direction of feed | TR (The direction is the 1pin of product is at the upper right when you hold reel on the left hand and you pull out the tape on the right hand) |



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- Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

| JAPAN | USA | EU | CHINA |
|-----------|-----------|------------|-----------|
| CLASS III | CLASS III | CLASS II b | CLASS III |
| CLASS IV | | CLASS III | |

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 - Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - Sealing or coating our Products with resin or other coating materials
 - Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of ionizer, friction prevention and temperature / humidity control).

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1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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